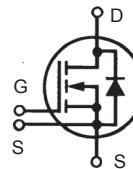


HiPerFET™ Power MOSFETs Single Die MOSFET

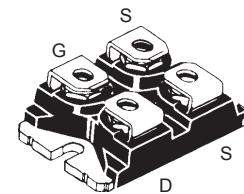
N-Channel Enhancement Mode
Avalanche Rated, High dv/dt, Low t_{rr}

IXFN 80N50



V_{DSS}	= 500	V
I_{D25}	= 80	A
$R_{DS(on)}$	= 55	$m\Omega$
t_{rr}	≤ 250	ns

miniBLOC, SOT-227 B (IXFN)
E153432



G = Gate D = Drain
S = Source

Either Source terminal of miniBLOC can be used as Main or Kelvin Source

Symbol	Test Conditions	Maximum Ratings		
V_{DSS}	$T_J = 25^\circ C$ to $150^\circ C$	500	V	
V_{DGR}	$T_J = 25^\circ C$ to $150^\circ C$; $R_{GS} = 1 M\Omega$	500	V	
V_{GS}	Continuous	± 20	V	
V_{GSM}	Transient	± 30	V	
I_{D25}	$T_c = 25^\circ C$, Chip capability	80	A	
I_{DM}	$T_c = 25^\circ C$, pulse width limited by T_{JM}	320	A	
I_{AR}	$T_c = 25^\circ C$	80	A	
E_{AR}	$T_c = 25^\circ C$	64	mJ	
E_{AS}	$T_c = 25^\circ C$	6	J	
dv/dt	$I_s \leq I_{DM}$, $dI/dt \leq 100 A/\mu s$, $V_{DD} \leq V_{DSS}$, $T_J \leq 150^\circ C$, $R_G = 2 \Omega$	5	V/ns	
P_D	$T_c = 25^\circ C$	780	W	
T_J		-55 ... +150	$^\circ C$	
T_{JM}		150	$^\circ C$	
T_{stg}		-55 ... +150	$^\circ C$	
V_{ISOL}	50/60 Hz, RMS $t = 1$ min $I_{ISOL} \leq 1$ mA $t = 1$ s	2500 3000	V~ V~	
M_d	Mounting torque Terminal connection torque	1.5/13	Nm/lb.in. Nm/lb.in.	
Weight		30	g	

Symbol	Test Conditions	Characteristic Values		
		($T_J = 25^\circ C$, unless otherwise specified)	min.	typ.
V_{DSS}	$V_{GS} = 0 V$, $I_D = 3$ mA	500		V
$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 8$ mA	2.5		4.5 V
I_{GSS}	$V_{GS} = \pm 20 V_{DC}$, $V_{DS} = 0$			± 200 nA
I_{DSS}	$V_{DS} = V_{DSS}$ $V_{GS} = 0 V$	$T_J = 25^\circ C$ $T_J = 125^\circ C$		100 μA 2 mA
$R_{DS(on)}$	$V_{GS} = 10 V$, $I_D = 0.5 \cdot I_{D25}$ Pulse test, $t \leq 300 \mu s$, duty cycle $d \leq 2\%$			55 $m\Omega$

Applications

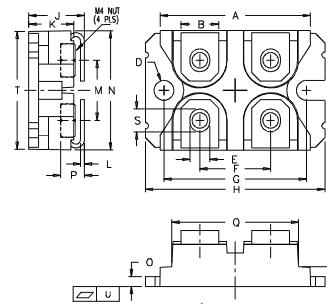
- DC-DC converters
- Battery chargers
- Switched-mode and resonant-mode power supplies
- DC choppers
- Temperature and lighting controls

Advantages

- Easy to mount
- Space savings
- High power density

Symbol	Test Conditions	Characteristic Values (T _J = 25°C, unless otherwise specified)		
		min.	typ.	max.
g_{fs}	V _{DS} = 15 V; I _D = 0.5 • I _{D25} , pulse test	50	70	S
C_{iss} C_{oss} C_{rss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz	9890	pF	
		1750	pF	
		460	pF	
$t_{d(on)}$ t_r $t_{d(off)}$ t_f	V _{GS} = 10 V, V _{DS} = 0.5 • V _{DSS} , I _D = 0.5 • I _{D25} R _G = 1 Ω (External),	61	ns	
		70	ns	
		102	ns	
		27	ns	
$Q_{G(on)}$ Q_{GS} Q_{GD}	V _{GS} = 10 V, V _{DS} = 0.5 • V _{DSS} , I _D = 0.5 • I _{D25}	380	nC	
		80	nC	
		173	nC	
R _{thJC}			0.16	K/W
R _{thCK}			0.05	K/W

miniBLOC, SOT-227 B



M4 screws (4x) supplied

Dim.	Millimeter Min.	Millimeter Max.	Inches Min.	Inches Max.
A	31.50	31.88	1.240	1.255
B	7.80	8.20	0.307	0.323
C	4.09	4.29	0.161	0.169
D	4.09	4.29	0.161	0.169
E	4.09	4.29	0.161	0.169
F	14.91	15.11	0.587	0.595
G	30.12	30.30	1.186	1.193
H	38.00	38.23	1.496	1.505
J	11.68	12.22	0.460	0.481
K	8.92	9.60	0.351	0.378
L	0.76	0.84	0.030	0.033
M	12.60	12.85	0.496	0.506
N	25.15	25.42	0.990	1.001
O	1.98	2.13	0.078	0.084
P	4.95	5.97	0.195	0.235
Q	26.54	26.90	1.045	1.059
R	3.94	4.42	0.155	0.174
S	4.72	4.85	0.186	0.191
T	24.59	25.07	0.968	0.987
U	-0.05	0.1	-0.002	0.004

Source-Drain Diode

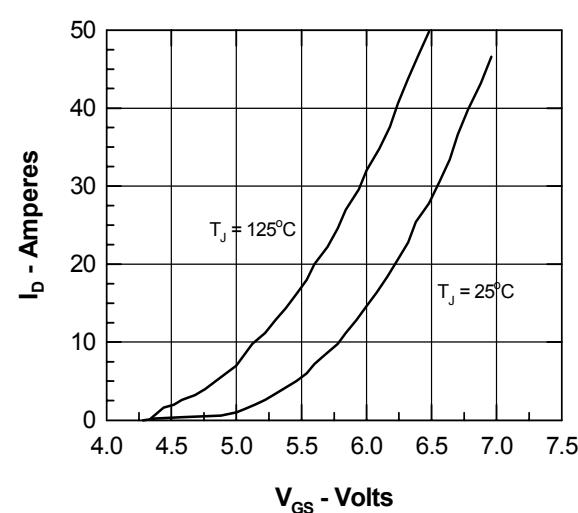
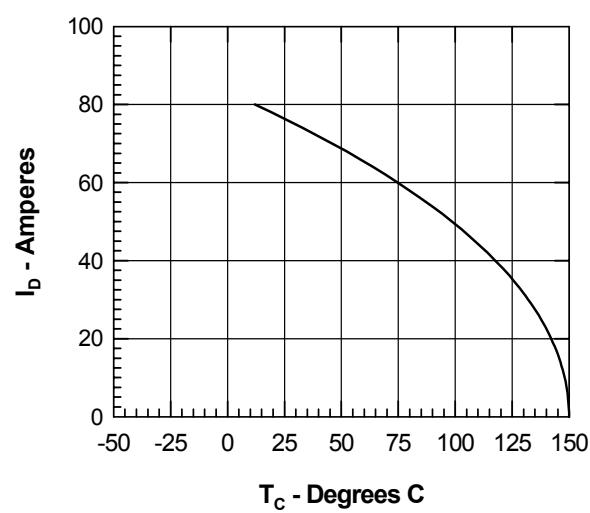
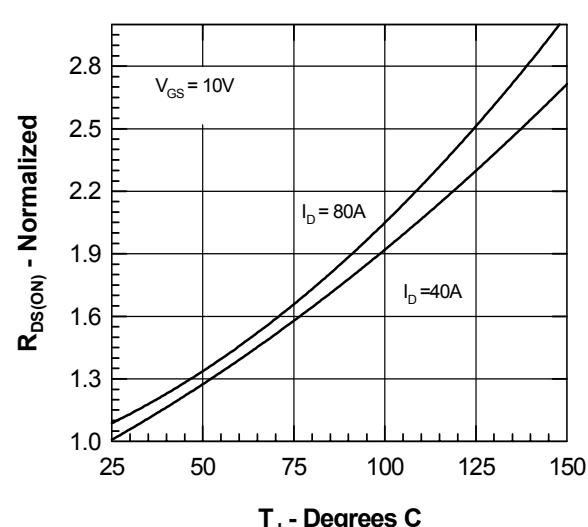
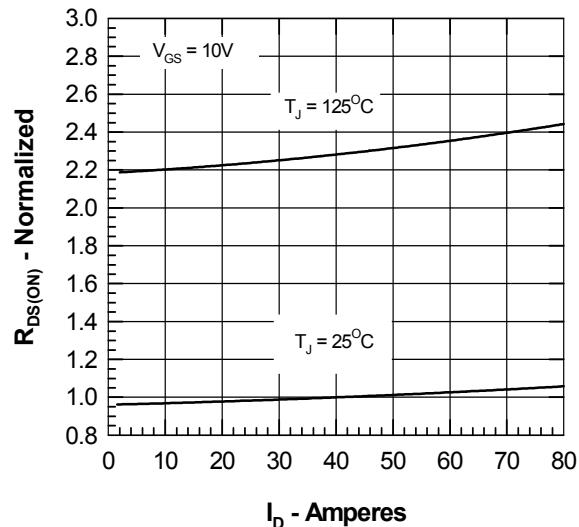
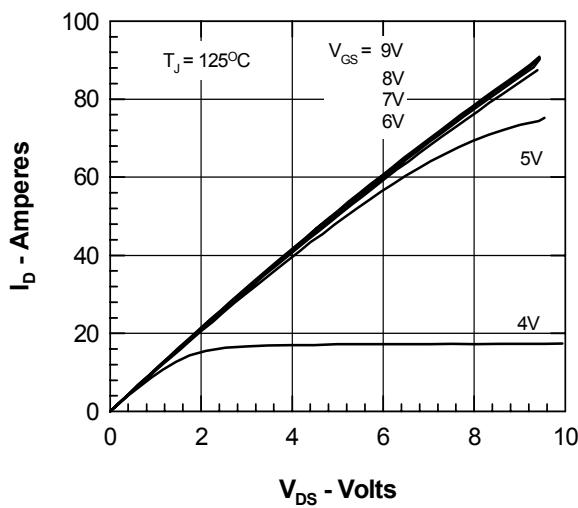
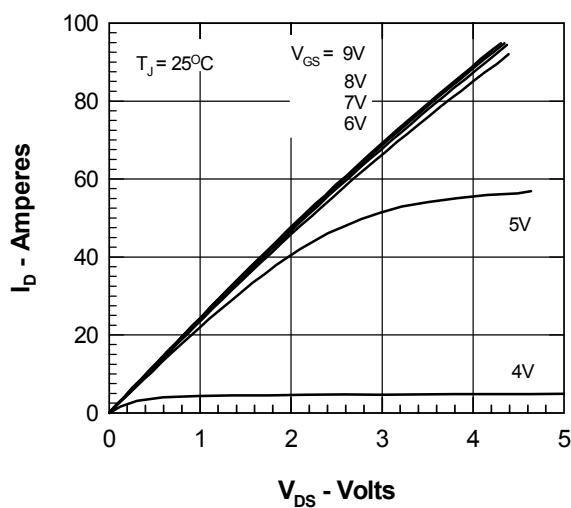
Characteristic Values

(T_J = 25°C, unless otherwise specified)

Symbol	Test Conditions	min.	typ.	max.
I _s	V _{GS} = 0 V		80	A
I _{SM}	Repetitive; pulse width limited by T _{JM}		320	A
V _{SD}	I _F = I _s , V _{GS} = 0 V, Pulse test, t < 300 ms, duty cycle d < 2 %		1.3	V
t _{rr} Q _{RM} I _{RM}	I _F = 30A, -di/dt = 100 A/μs, V _R = 100 V	1.2	250	ns
		8	μC	A

IXYS reserves the right to change limits, test conditions, and dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents:
4,835,592 4,881,106 5,017,508 5,049,961 5,187,117 5,486,715 6,306,728B1
4,850,072 4,931,844 5,034,796 5,063,307 5,237,481 5,381,025



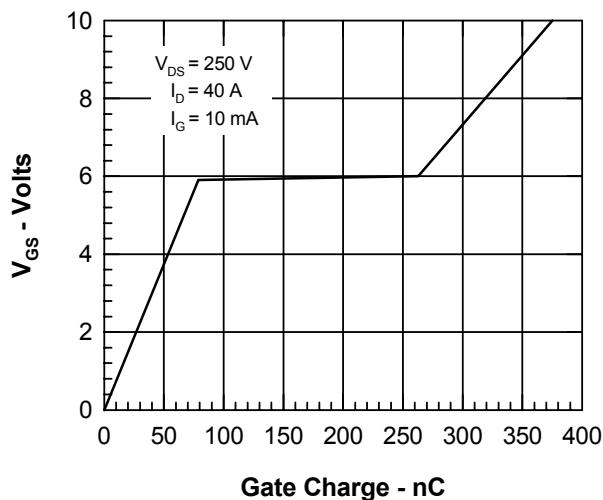


Fig. 7 Gate Charge Characteristic Curve

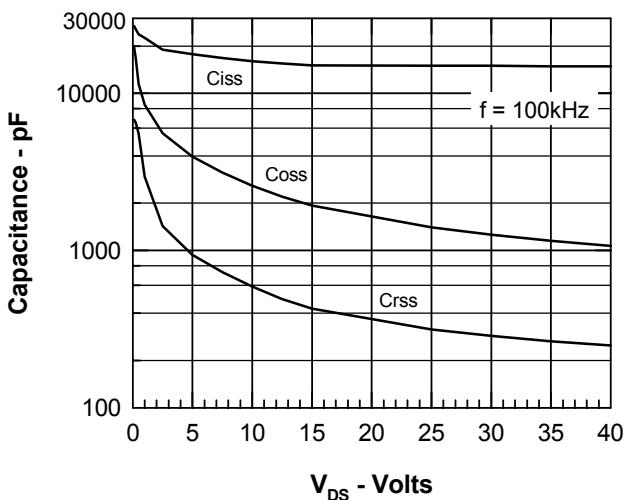


Fig. 8 Capacitance Curves

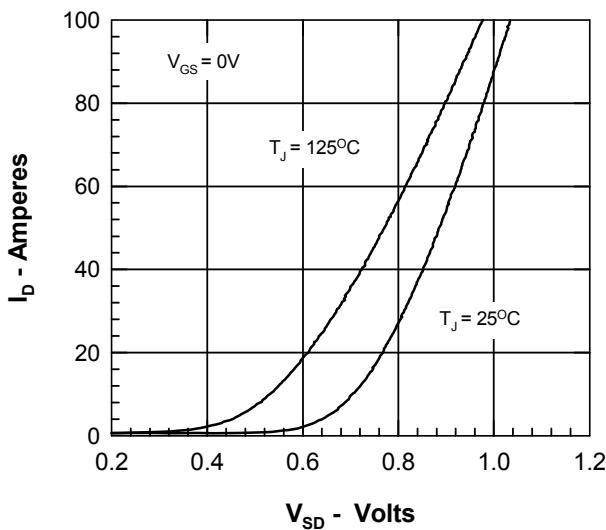


Fig. 9. Source-to-Drain Voltage Drop

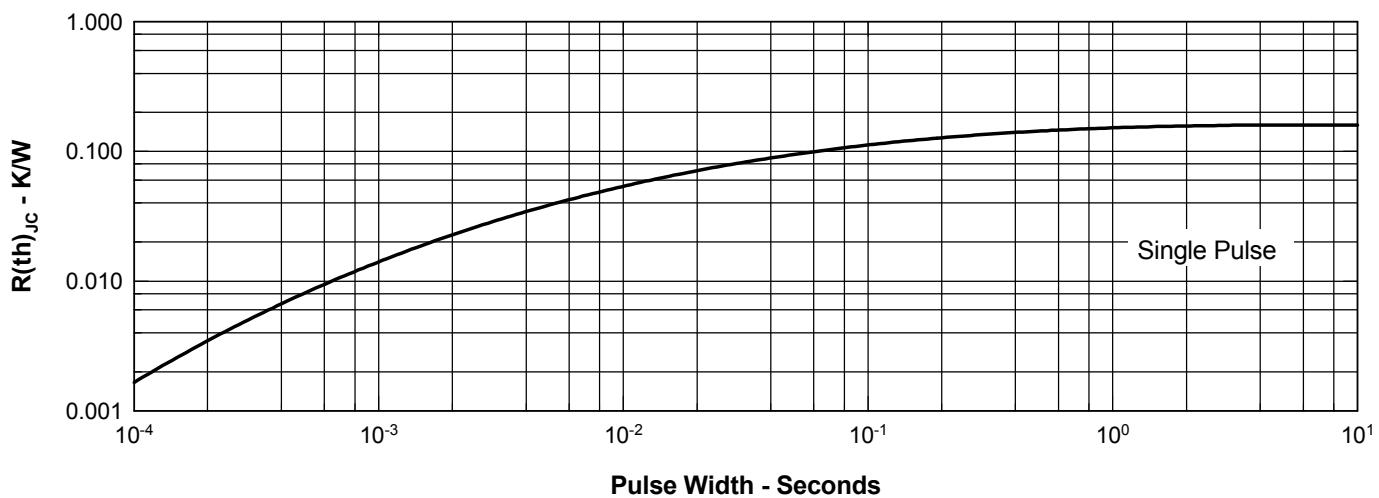


Fig. 10. Transient Thermal Resistance



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